

RoHS

COMPLIANT HALOGEN

FREE

DMN3112SQ-7-VB Datasheet

N-Channel 30-V (D-S) MOSFET

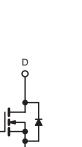
PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)		
30	0.030 at V _{GS} = 10 V	6.5	4.5 nC		
- 50	0.033 at V _{GS} = 4.5 V	6.0	4.5110		

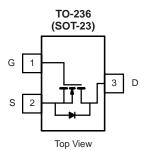
FEATURES

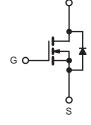
- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

DC/DC Converter









Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V _{GS}	± 20		
	T _C = 25 °C		6.5 ^a		
Continuous Drain Current ($T_1 = 150 \ ^{\circ}C$)	T _C = 70 °C		6.0		
Continuous Drain Current (1) = 150 C)	T _A = 25 °C	I _D	5.3		
	T _A = 70 °C	1	5.0	A	
Pulsed Drain Current		I _{DM}	25		
	T _C = 25 °C		1.4		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	0.9 ^{b, c}		
	T _C = 25 °C		1.7		
Maximum Power Dissipation	T _C = 70 °C	P _D	1.1	W	
Maximum Power Dissipation	T _A = 25 °C		1.1 ^{b, c}	VV	
	T _A = 70 °C	1	0.7 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	
Soldering Recommendations (Peak Tempera		260	-0		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 5 s	R _{thJA}	90	115	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	60 75 6//		0/11	

Notes:

a. Package limited

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under steady state conditions is 130 °C/W.

Test Conditions $_{S} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$ $_{I_{D}} = 250 \mu\text{A}$ $_{S} = \text{V}_{GS}, \text{ I}_{D} = 250 \mu\text{A}$ $_{S} = 0 \text{V}, \text{V}_{GS} = \pm 20 \text{V}$ $_{S} = 30 \text{V}, \text{V}_{GS} = 0 \text{V}$ $_{O} \text{V}, $	Min. 30 0.7	Typ. 31 - 5 1.1	2.0	V W WV/°C	
$I_{D} = 250 \ \mu A$ $S = V_{GS}, I_{D} = 250 \ \mu A$ $S = 0 \ V, V_{GS} = \pm 20 \ V$ $S = 30 \ V, V_{GS} = 0 \ V$ $V_{GS} = 0 \ V, T_{J} = 55 \ ^{\circ}C$		- 5	2.0		
$I_{D} = 250 \ \mu A$ $S = V_{GS}, I_{D} = 250 \ \mu A$ $S = 0 \ V, V_{GS} = \pm 20 \ V$ $S = 30 \ V, V_{GS} = 0 \ V$ $V_{GS} = 0 \ V, T_{J} = 55 \ ^{\circ}C$		- 5	2.0		
$I_{S} = V_{GS}$, $I_{D} = 250 \ \mu A$ $I_{S} = 0 \ V$, $V_{GS} = \pm 20 \ V$ $I_{S} = 30 \ V$, $V_{GS} = 0 \ V$ $0 \ V$, $V_{GS} = 0 \ V$, $T_{J} = 55 \ ^{\circ}C$	0.7	- 5	2.0	mV/°0	
$V_{S} = 0 V, V_{GS} = \pm 20 V$ $V_{S} = 30 V, V_{GS} = 0 V$ $V, V_{GS} = 0 V, T_{J} = 55 °C$	0.7	-	2.0	mV/°C	
$V_{S} = 0 V, V_{GS} = \pm 20 V$ $V_{S} = 30 V, V_{GS} = 0 V$ $V, V_{GS} = 0 V, T_{J} = 55 °C$	0.7	1.1	20		
$_{\rm S}$ = 30 V, V _{GS} = 0 V 0 V, V _{GS} = 0 V, T _J = 55 °C				V	
) V, V _{GS} = 0 V, T _J = 55 °C			± 100	nA	
			1	- μΑ	
$_{\rm S}$ \geq 5 V, V _{GS} = 10 V			10		
	10			A	
_{SS} = 10 V, I _D = 3.2 A		0.030		Ω	
_S = 4.5 V, I _D = 2.8 A		0.033			
_{oS} = 15 V, I _D = 4.8 A		11		S	
		335			
V_{DS} = 15 V, V_{GS} = 0 V, f = 1 MHz		45		pF	
		17			
5 V, V _{GS} = 10 V, I _D = 3.4 A		4.5	6.7	-	
		2.1	3.2		
V _{DS} = 15 V, V _{GS} = 4.5 V, I _D = 3.4 A		0.85		nC	
		0.65		1	
f = 1 MHz	0.8	4.4	8.8	Ω	
		12	20		
V_{DD} = 15 V, R _L = 5.6 Ω I _D \cong 2.7 A, V _{GEN} = 4.5 V, R _g = 1 Ω		50	75	-	
		12	20		
-		22	35	1	
		5	10	ns	
_D = 15 V, R _I = 5.6 Ω		12	20	1	
$I_D \cong 2.7 \text{ A}, V_{\text{GEN}} = 10 \text{ V}, \text{R}_g = 1 \Omega$		10	15		
		5	10		
T _C = 25 °C			1.4		
•			15	A	
= 2.7 A, V _{GS} = 0 V		0.8		V	
, 00 -	+			ns	
-				nC	
	<u> </u>		10		
dl/dt = 100 A/µs, T _J = 25 °C				ns	
	= 2.7 A, V _{GS} = 0 V dl/dt = 100 A/µs, T _J = 25 °C		10	$= 2.7 \text{ A}, \text{ V}_{\text{GS}} = 0 \text{ V} \qquad 0.8 \qquad 1.2$ $10 \qquad 20$ $dI/dt = 100 \text{ A}/\mu\text{s}, \text{ T}_{\text{J}} = 25 \text{ °C} \qquad 5 \qquad 10$ 6	

Notes:

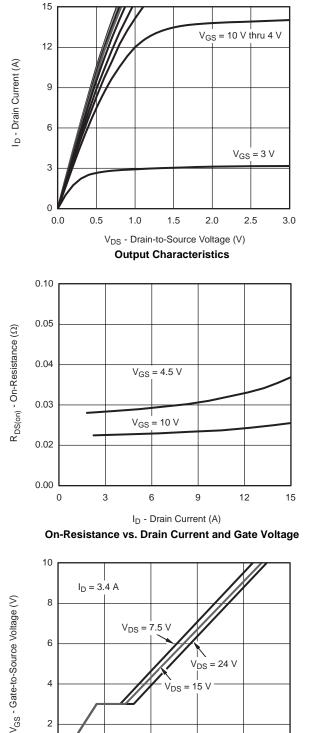
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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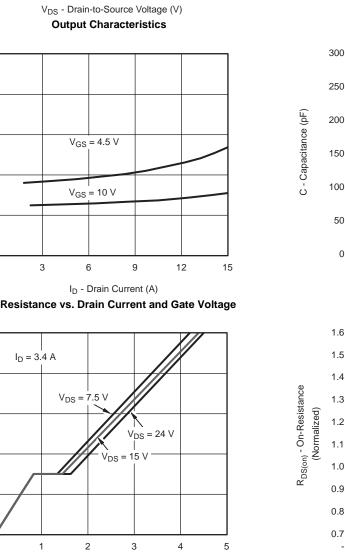


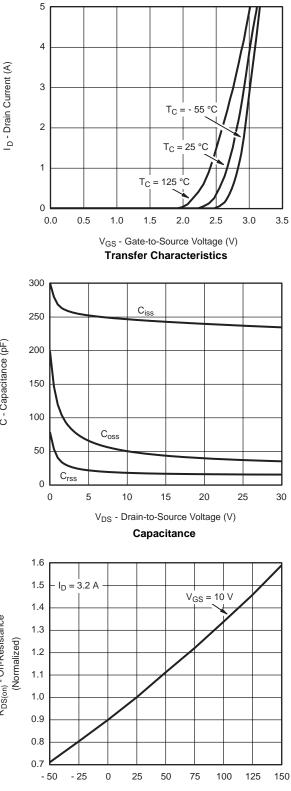


Qg - Total Gate Charge (nC)

Gate Charge

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





T_J - Junction Temperature (°C) **On-Resistance vs. Junction Temperature**

6

4

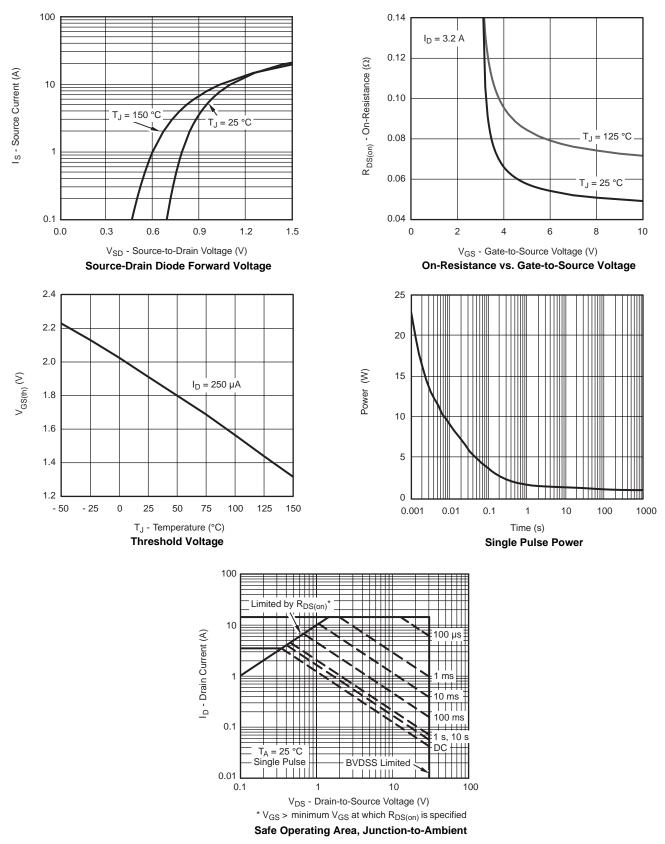
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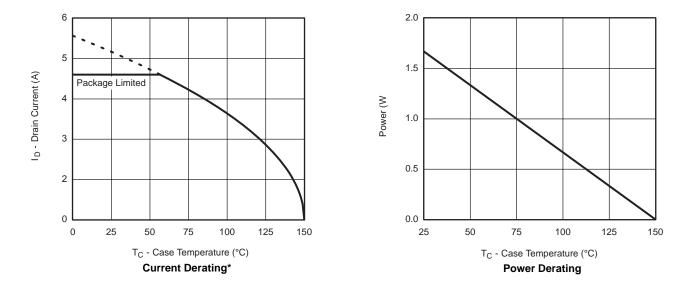
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





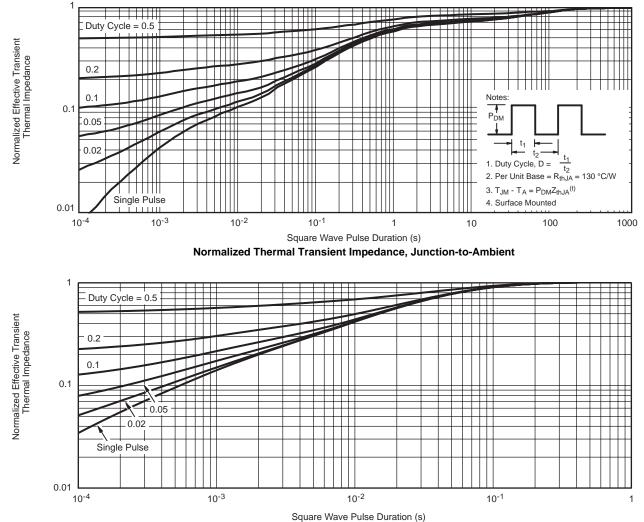


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot



SOT-23 (TO-236): 3-LEAD







Dim	MILLIN	METERS	INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A ₁	0.01	0.10	0.0004	0.004	
A ₂	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
C	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E ₁	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e ₁	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L ₁	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	
ECN: S-03946-Rev. K, 09- DWG: 5479	Jul-01				



RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)

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